

NC600 (Sn/Ag/Cu) NO CLEAN DELTA® SOLDER WIRE

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Description

Flux Core

Delta® Solder Wire NC600 is a no clean flux system that is available with both lead-containing alloys and high melting temperature Sn/Ag/Cu alloys, such as SAC305 and SAC405. It provides the fluxing activity levels that promote fast wetting action and maximum wetting spread. Utilizing synthetically refined resin and very effective activator, NC600 wets and spreads like an RA type flux core. NC600 exhibits virtually no spattering and leaves minimal residue.

Main Features

- Excellent wettability
- □ Yields clear, non-conductive residues
- □ RoHs compliant (SAC alloys)

Technical Data (Flux Extract)

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	Specification	Test Method
Color & Appearance	Light yellow opaque solid	Visual
Flux Classification	RELO	IPC-J-STD-004B
Copper Mirror	No removal of copper film	IPC-TM-650 2.3.32
Silver Chromate	Pass	IPC-TM-650 2.3.33
Corrosion	Pass	IPC-TM-650 2.6.15
SIR	>1 x 108 ohms	IPC-TM-650 2.6.3.3
Electromigration	Pass	Bellcore GR-78-CORE 13.1.4
Post Reflow Flux Residue	55%	TGA Analysis
Acid Value (mgKOH/g)	190-210	IPC-TM-650 2.3.13
Flux Residue Dryness	Pass	IPC-TM-650 2.4.47
Spitting of Flux-Cored Solder	0.3%	IPC-TM-650 2.4.48
Solder Spread	>100 mm ²	IPC-TM-650 2.4.46

Wire Diameter

Delta Solder Wire NC600 with tin/silver/copper alloys is available in a variety of diameters. The chosen diameter is based on application methods, pad size, and desired solder joint volume. Generally, the diameter of the wire should be slightly larger than the width/diameter of the joint or connection to be soldered. Below is a list of standard diameters.

Standard wire diameters

Diamter/Inch Diameter/mm	0.125 3.18	0.092 2.33	0.062 1.57	0.050 1.27	0.040 1.01	0.032 0.81	0.028 0.71	0.025 0.63	0.020 0.51	0.015 0.38	0.010 0.25
Std.Wire	11	13	16	18	19	21	22	23	25	28	31
Gauge											
Tolerance, in.	+/-0.006	+/-0.005	+/-0.002	+/-0.002	+/-0.002	+/-0.002	+/-0.002	+/-0.002	+/-0.002	+/-0.002	+/-0.002

Flux Percentage

Qualitek utilizes a state-of-the-art automatic wire extrusion and wire drawing machines to manufacture consistent solder. The introduction of flux core in the wire extrusion process involves continual monitoring of flux percentage to ensure minimal flux voids and irregular wire. Typical flux percentage for high temperature lead-free SAC-containing alloy solder is <u>1.1 - 3.3%</u>.

Physical Properties

Solder Composition

Qualitek has developed a no clean resin based core flux with tin/silver/copper (SAC) alloys. Qualitek SAC alloys conform to and exceed the impurity requirements of IPC-J-STD-006C.

Typical Analysis														
	Sn	Ag	Cu	Pb	Sb	Bi	In	As	Fe	Ni	Cd	Al	Zn	Au
LF955-38	Bal	3.6-4.0	0.5-0.9	0.070 Max	0.200 Max	0.100 Max	0.100 Max	0.030 Max	0.020 Max	0.010 Max	0.002 Max	0.005 Max	0.003 Max	0.050 Max
LF958-35	Bal	3.3-3.7	0.5-0.9	0.070 Max	0.200 Max	0.100 Max	0.100 Max	0.030 Max	0.020 Max	0.010 Max	0.002 Max	0.005 Max	0.003 Max	0.050 Max
LF965-30	Bal	2.8-3.2	0.3-0.7	0.070 Max	0.200 Max	0.100 Max	0.100 Max	0.030 Max	0.020 Max	0.010 Max	0.002 Max	0.005 Max	0.003 Max	0.050 Max
LF217	Bal	3.8-4.2	0.3-0.7	0.070 Max	0.200 Max	0.100 Max	0.100 Max	0.030 Max	0.020 Max	0.010 Max	0.002 Max	0.005 Max	0.003 Max	0.050 Max

	Sn/Ag/Cu	Sn63/Pb37
Melting Point, °C	217-221	183 E
Hardness, Brinell	15HB	14HB
Coefficient of Thermal Expansion	Pure Sn= 23.5	24.7
Tensile Strength, psi	4312	4442
Density, g/cc	7.39	8.42
Electrical Resistivity , (μοhm-cm)	13.0	14.5
Electrical Conductivity, %IACS	16.6	11.9

	Sn/Ag/Cu	Sn63/Pb37
Yield Strength, psi	3724	3950
Total Elongation,%	27	48
Joint Shear Strength, at 0.1mm/min 20 °C	27	23
Joint Shear Strength, at 0.1mm/min 100 °C	17	14
Creep Strength, N/mm ² at 0.1mm/min 20 °C	13.0	3.3
Creep Strength, N/mm ² at 0.1mm/min 100 °C	5	1
Thermal Conductivity, W/m-K	58.7	50.9

Flux Residues & Cleaning

NC600 is a no clean formulation; therefore, residue removal is not required for typical applications. If residue removal is desired, the use of Everkleen 1005 Buffered Saponifier with a 5-15% concentration in hot 60 °C (140 °F) de-ionized water will aid in residue removal.

Storage & Shelf Life

Solder wire storage should be in a 65-80 °F environment away from direct heat. We recommend using gloves when handling solder wire directly. Solder wire has an indefinite shelf life.

Packaging

Qualitek flux-core wire and solid wire are packed in 12.5lb -box of ½ lb spools

25 lb -box of 1 lb spools

12.5kg -box of ½ kg spools

8 kg -box of 1kg spools 40 lb -box of 5 lb spools

20 lb -box of 20 lb spools

Disposal

Sn/Ag/Cu NC600 lead-free solder should be disposed of in accordance with local, regional, national and international regulations.

Qualitek® and Delta® are brands of Qualitek International, Inc. For Health and Safety information refer to Safety Data Sheet.